

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

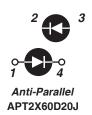
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

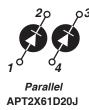
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China















APT2X61D20J APT2X60D20J 200V 200V 60A 60A

DUAL DIE ISOTOP® PACKAGE

ULTRAFAST SOFT RECOVERY RECTIFIER DIODE

PRODUCT APPLICATIONS	PRODUCT FEATURES	PRODUCT BENEFITS
 Anti-Parallel Diode Switchmode Power Supply 	 Ultrafast Recovery Times 	• Low Losses
-Inverters • Free Wheeling Diode	 Soft Recovery Characteristics 	 Low Noise Switching
-Motor Controllers -Converters	Popular SOT-227 Package	 Cooler Operation
Snubber Diode	 Low Forward Voltage 	Higher Reliability Systems
Uninterruptible Power Supply (UPS) Induction Heating	High Blocking Voltage	 Increased System Power Density
High Speed Rectifiers	 Low Leakage Current 	,

MAXIMUM RATINGS

All Ratings: $T_C = 25^{\circ}C$ unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT2X61_60D20J	UNIT
V _R	Maximum D.C. Reverse Voltage		
V _{RRM}	Maximum Peak Repetitive Reverse Voltage	200	Volts
V _{RWM}	Maximum Working Peak Reverse Voltage		
I _{F(AV)}	Maximum Average Forward Current (T _C = 122°C, Duty Cycle = 0.5)	60	
I _{F(RMS)}	RMS Forward Current (Square wave, 50% duty)	107	Amps
I _{FSM}	Non-Repetitive Forward Surge Current (T _J = 45°C, 8.3ms)	600	
T _J ,T _{STG}	Operating and StorageTemperature Range	-55 to 175	°C
T _L	Lead Temperature for 10 Sec.	300	1 .0

STATIC ELECTRICAL CHARACTERISTICS

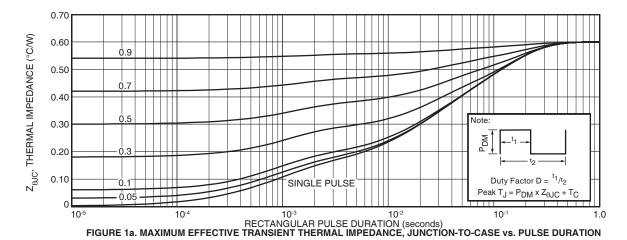
Symbol	Characteristic / Test Conditions		MIN	TYP	MAX	UNIT
V _F	Forward Voltage	I _F = 60A		1.1	1.3	Volts
		I _F = 120A		1.4		
		I _F = 60A, T _J = 125°C		0.9		
I _{RM}	Maximum Reverse Leakage Current	V _R = V _R Rated			250	- μΑ
		V _R = V _R Rated, T _J = 125°C			500	
C _T	Junction Capacitance, V _R = 200V			210		pF

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
t _{rr}	Reverse Recovery Time I _F = 1A, di _F /dt =	$-100A/\mu s$, $V_R = 30V$, $T_J = 25^{\circ}C$	-	30		20
t _{rr}	Reverse Recovery Time		-	31		ns
Q _{rr}	Reverse Recovery Charge	$I_F = 60A$, $di_F/dt = -200A/\mu s$ $V_R = 133V$, $T_C = 25^{\circ}C$	-	60		nC
I _{RRM}	Maximum Reverse Recovery Current		-	3	-	Amps
t _{rr}	Reverse Recovery Time	$I_F = 60A$, $di_F/dt = -200A/\mu s$ $V_R = 133V$, $T_C = 125^{\circ}C$	-	60		ns
Q _{rr}	Reverse Recovery Charge		-	250		nC
I _{RRM}	Maximum Reverse Recovery Current		•	7	-	Amps
t _{rr}	Reverse Recovery Time	$I_F = 60A$, $di_F/dt = -1000A/\mu s$ $V_R = 133V$, $T_C = 125^{\circ}C$	-	40		ns
Q _{rr}	Reverse Recovery Charge		-	540		nC
I _{RRM}	Maximum Reverse Recovery Current		-	24		Amps

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$R_{ hetaJC}$	Junction-to-Case Thermal Resistance			.60	°C/W
$R_{ hetaJA}$	Junction-to-Ambient Thermal Resistance			20	
W _T Packaç	Package Weight		1.03		oz
			29.2		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

APT Reserves the right to change, without notice, the specifications and information contained herein.

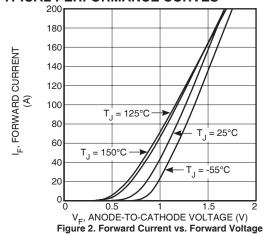


Junction temp (°C) 0.159 °C/W 0.00560 J/°C 0.255 °C/W 0.0849 J/°C 0.186 °C/W 0.489 J/°C 0.489 J/°C

RC MODEL

FIGURE 1b, TRANSIENT THERMAL IMPEDANCE MODEL

TYPICAL PERFORMANCE CURVES



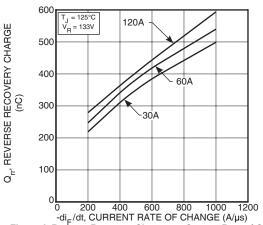
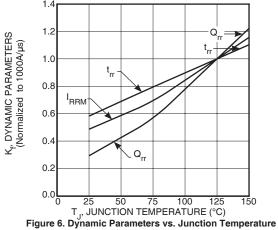
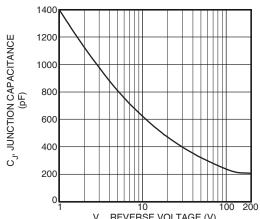


Figure 4. Reverse Recovery Charge vs. Current Rate of Change





V_R, REVERSE VOLTAGE (V)
Figure 8. Junction Capacitance vs. Reverse Voltage

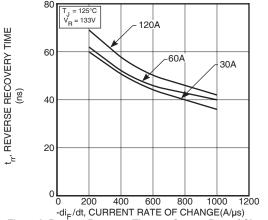


Figure 3. Reverse Recovery Time vs. Current Rate of Change

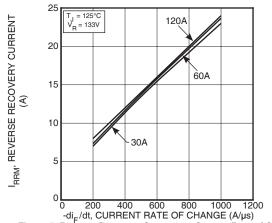


Figure 5. Reverse Recovery Current vs. Current Rate of Change

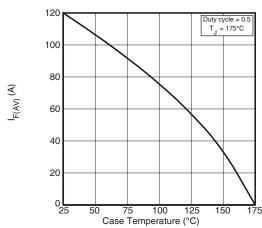


Figure 7. Maximum Average Forward Current vs. CaseTemperature

0.25 I_{RRM}

5

2

Figure 9. Diode Test Circuit

- 1 I_F Forward Conduction Current
- 2 di_F/dt Rate of Diode Current Change Through Zero Crossing.
- 3 I_{RRM} Maximum Reverse Recovery Current.
- 4 t_{rr} Reverse Recovery Time, measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I_{RRM} and 0.25•I_{RRM} passes through zero.
- Q_{rr} Area Under the Curve Defined by I_{RRM} and t_{rr}.

Figure 10, Diode Reverse Recovery Waveform and Definitions

